

EPO-TEK® H20E-SLR-MX

Technical Data Sheet For Reference Only Electrically Conductive Epoxy

Date: November 2019 Recommended Cure: 140°C / 10 Minutes

Rev: No. of Components: Two Mix Ratio by Weight: 100:15

Specific Gravity: Part A: 2.29 Part B: 1.11

Pot Life: 20 Hours

Shelf Life- Bulk: One year at room temperature

Minimum Alternative Cure(s):

May not achieve performance properties listed below

140°C / 35 Seconds 120°C / 15 Minutes 100°C / 2 Hours 80°C / 4 Hours

NOTES:

• Container(s) should be kept closed when not in use.

• Filled systems should be stirred thoroughly before mixing and prior to use.

• Performance properties (rheology, conductivity, others) of the product may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other packages.

Product Description: EPO-TEK® H20E-SLR-MX is a two-component, electrically conductive, epoxy for meter mix dispensing applications. It is designed for solar ribbon bonding of photovoltaic modules. It provides the electrical back-contact for ribbon stringing of solar cells into modules and panels.

Typical Properties: Cure condition: 140°C / 10 Minutes Different batches, conditions & applications yield differing results. Data below is not guaranteed. To be used as a guide only, not as a specification. * denotes test on lot acceptance basis

PHYSICAL PROPERTIES:			
* Color (before cure):		Part A: Silver	Part B: Amber
* Consistency:		Smooth thixotro	ppic paste
* Viscosity (23°C) @ 50 rpm:		4,341	cPs
Thixotropic Index:		4.1	
* Glass Transition Temp:		≥ 78	°C (Dynamic Cure: 20-200°C/ISO 25 Min; Ramp -10-200°C @20°C/Min)
Coefficient of Thermal Expansion	on (CTE):		
	Below Tg:	48	x 10 ⁻⁶ in/in°C
,	Above Tg:	228	x 10 ⁻⁶ in/in°C
Shore D Hardness:		53	
Lap Shear @ 23°C:		1,040	psi
Die Shear @ 23°C:		≥ 10	Kg 3,556 psi
Degradation Temp:		388	°C
Weight Loss:			
	@ 200°C:	0.61	%
	@ 250°C:	1.99	%
	@ 300°C:	3.47	%
Suggested Operating Tempera	ture:	< 300	°C (Intermittent)
Storage Modulus:		1,041,110	psi
* Particle Size:		≤ 20	microns

ELECTRICAL AND THERMAL PROPERTIES:		
Thermal Conductivity:	1.2	W/mK
* Volume Resistivity @ 23°C:	≤ 0.004	Ohm-cm



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EPO-TEK® H20E-SLR-MX Advantages & Suggested Application Notes:

- Meter mix format enables cost reduction by eliminating frozen shipments and freezer storage, maximizing pot life on the manufacturing floor, and reduction in precious metal waste.
- Strengths include dispensable rheology, fast cure, electrical contact resistance similar to solder and a long pot life.
- Photovoltaic Suggested Applications:
 - o Electrically conductive stringing of thin film, organic and crystalline Si solar cells.
 - Compatible with SnCu and AgCu metalized solar ribbons, and TCO substrates such as ITO, ZnO and SnO.
 - o Versatility in ribbon bonding geometries, such as dotted or continuous line.
 - In-line/in-situ curing processes in <1 minute at 140°C can be achieved.
 - Reliable green strength holds solar ribbons in position prior to cure.
 - Low temperature cure is well suited for CIGS and OPV/DSC solar cells requiring a low temperature process.
 - EVA film lamination post processing such as 150°C/15-30 minutes enhances performance properties.
 - o Suitable for use on IEC 61646, IEC 61730 and UL 1703 certified solar panels.